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ATTACHMENT CIn the Claims

Claims 1-11: (canceled)

- 5 12. (new) A surface covering comprising a substrate and a top coating wherein the top coating comprises between 0.01 and 10% w/w of particles with a conductive coating having a mean size between 0.1 and 50 μm , based on the weight of the top coating.
13. (new) The surface covering according to claim 12, wherein the particles are substantially spherical.
- 10 14. (new) The surface covering according to claim 12, wherein the particles comprise a coating of silver, aluminum, copper, nickel, gold or an alloy thereof with another metals.
- 15 15. (new) The surface covering according to claim 12, wherein the particles have a dry bulk resistivity of between 0.0001 and 0.01 Ohms/cm.
16. (new) The surface covering according to claim 12, wherein the top coating comprises a PU-dispersion, a PU-solution, a 2-components PU, a PU acrylate, an epoxy acrylate, a polyester acrylate, a polyether acrylate, a silicone acrylate or a mixture thereof
- 20 17. (new) The surface covering of claim 16, wherein the coating comprises an urethane derived polymer preferably polyurethane.

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18. (new) The surface covering of claim 16, wherein the coating comprises a water based UV-curable PU-acrylate dispersion with a dry content of between 5 % and 80% w/w , preferably between 20 and 60 % w/w.

5 19. (new) The surface covering according to claim 16 , wherein the top coating has a thickness of between 0,5 μm to 100 μm

20. (new) The surface covering according to claim 12, wherein the substrate is a conductive and antistatic flooring.

21. (new) The surface covering according to claim 12, wherein the substrate is a
10 PVC, polyolefin or rubber based flooring with vertical conductive channels.

22. (new) The surface covering according to claim 13, wherein the particles comprise a coating of silver, aluminum, copper, nickel, gold or an alloy thereof with another metals.